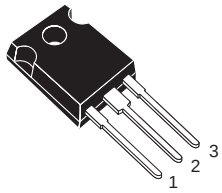
STW88N65M5
STWA88N65M5

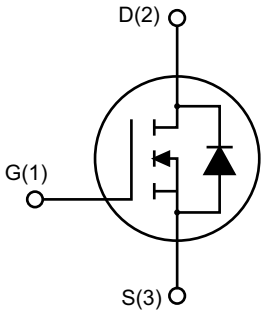
N-channel 650 V, 0.024 Ω typ., 84 A, MDmesh™ V Power MOSFETs in TO-247 and TO-247 long leads packages

Datasheet - production data



TO-247
TO-247 long leads

Figure 1. Internal schematic diagram



Features

Order codes	V_{DSS} @$T_{jmax.}$	$R_{DS(on)}$ max.	I_D
STW88N65M5	710 V	0.029 Ω	84 A
STWA88N65M5			

- Worldwide best $R_{DS(on)}$ in TO-247
- Higher V_{DSS} rating
- Higher dv/dt capability
- Excellent switching performance
- Easy to drive
- 100% avalanche tested

Applications

- High efficiency switching applications:
  - Servers
  - PV inverters
  - Telecom infrastructure
  - Multi kW battery chargers

Description

These devices are N-channel MDmesh™ V Power MOSFETs based on an innovative proprietary vertical process technology, which is combined with STMicroelectronics' well-known PowerMESH™ horizontal layout structure. The resulting product has extremely low on-resistance, which is unmatched among silicon-based Power MOSFETs, making it especially suitable for applications which require superior power density and outstanding efficiency.

Table 1. Device summary

Order codes	Marking	Packages	Packaging
STW88N65M5	88N65M5	TO-247	Tube
STWA88N65M5		TO-247 long leads	

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1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{GS}	Gate- source voltage	±25	V
I_D	Drain current (continuous) at T_C = 25 °C	84	A
I_D	Drain current (continuous) at T_C = 100 °C	50.5	A
I_{DM} (1)	Drain current (pulsed)	336	A
P_{TOT}	Total dissipation at T_C = 25 °C	450	W
I_{AR}	Max current during repetitive or single pulse avalanche (pulse width limited by T_{JMAX})	15	A
E_{AS}	Single pulse avalanche energy (starting T_j = 25 °C, I_D = I_{AR}, V_{DD} = 50 V)	2000	mJ
dv/dt (2)	Peak diode recovery voltage slope	15	V/ns
T_{stg}	Storage temperature	- 55 to 150	°C
T_j	Max. operating junction temperature	150	°C

1. Pulse width limited by safe operating area
2. $I_{SD} \leq$ 84 A, di/dt = 400 A/µs, peak $V_{DS} < V_{(BR)DSS}$, V_{DD} = 400 V

Table 3. Thermal data

Symbol	Parameter	Value	Unit
$R_{thj\text{-}case}$	Thermal resistance junction-case max	0.28	°C/W
$R_{thj\text{-}amb}$	Thermal resistance junction-ambient max	50	°C/W

2 Electrical characteristics

(T_C = 25 °C unless otherwise specified)

Table 4. On /off states

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	V_{GS} = 0, I_D = 1 mA	650			V
I_{DSS}	Zero gate voltage drain current	V_{GS} = 0, V_{DS} = 650 V			1	µA
		V_{GS} = 0, V_{DS} = 650 V, T_C=125 °C			100	µA
I_{GSS}	Gate-body leakage current	V_{DS} = 0, V_{GS} = ± 25 V			± 100	nA
$V_{GS(th)}$	Gate threshold voltage	V_{DS} = V_{GS}, I_D = 250 µA	3	4	5	V
$R_{DS(on)}$	Static drain-source on- resistance	V_{GS} = 10 V, I_D = 42 A		0.024	0.029	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{iss}	Input capacitance	V_{GS} = 0, V_{DS} = 100 V, f = 1 MHz	-	8825	-	pF
C_{oss}	Output capacitance		-	223	-	pF
C_{rss}	Reverse transfer capacitance		-	11	-	pF
$C_{o(tr)}$(1)	Equivalent capacitance time related	V_{GS} = 0, V_{DS} = 0 to 520 V	-	778	-	pF
$C_{o(er)}$(2)	Equivalent capacitance energy related	V_{GS} = 0, V_{DS} = 0 to 520 V	-	202	-	pF
R_G	Intrinsic gate resistance	f = 1 MHz open drain	-	1.79	-	Ω
Q_g	Total gate charge	V_{DD} = 520 V, I_D = 42 A, V_{GS} = 10 V (see *Figure 16*)	-	204	-	nC
Q_{gs}	Gate-source charge		-	51	-	nC
Q_{gd}	Gate-drain charge		-	84	-	nC

1. $C_{o(tr)}$ is a constant capacitance value that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS}.
2. $C_{o(er)}$ is a constant capacitance value that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS}.

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(V)}$	Voltage delay time	V_{DD} = 400 V, I_D = 56 A, R_G = 4.7 Ω, V_{GS} = 10 V (see *Figure 17*) (see *Figure 20*)	-	141	-	ns
$t_{r(V)}$	Voltage rise time		-	16	-	ns
$t_{f(i)}$	Current fall time		-	29	-	ns
$t_{c(off)}$	Crossing time		-	56	-	ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
I_{SD}	Source-drain current		-		84	A
I_{SDM} (1)	Source-drain current (pulsed)		-		336	A
V_{SD} (2)	Forward on voltage	I_{SD} = 84 A, V_{GS} = 0	-		1.5	V
t_{rr}	Reverse recovery time	I_{SD} = 84 A, di/dt = 100 A/µs V_{DD} = 100 V (see *Figure 17*)	-	544		ns
Q_{rr}	Reverse recovery charge		-	14		µC
I_{RRM}	Reverse recovery current		-	50		A
t_{rr}	Reverse recovery time	I_{SD} = 84 A, di/dt = 100 A/µs V_{DD} = 100 V, T_j = 150 °C (see *Figure 17*)	-	660		ns
Q_{rr}	Reverse recovery charge		-	20		µC
I_{RRM}	Reverse recovery current		-	60		A

1. Pulse width limited by safe operating area
2. Pulsed: pulse duration = 300 µs, duty cycle 1.5%

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

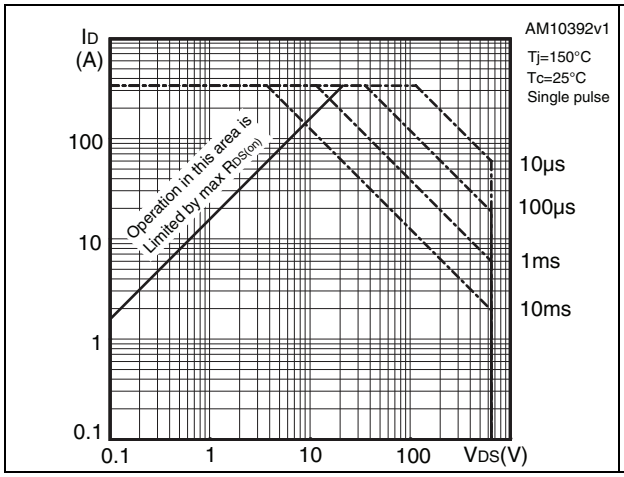


Figure 3. Thermal impedance

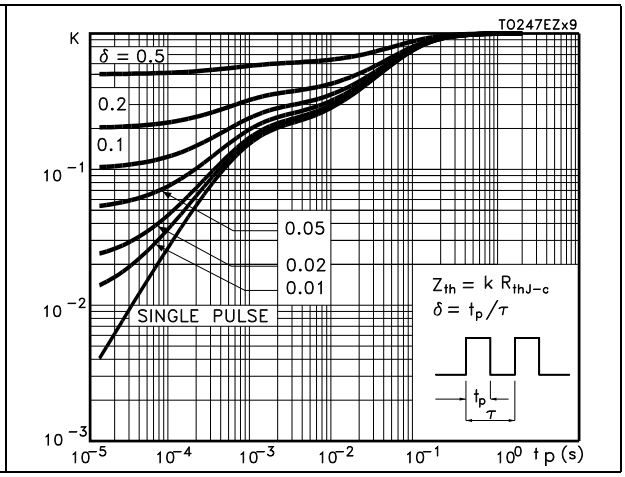


Figure 4. Output characteristics

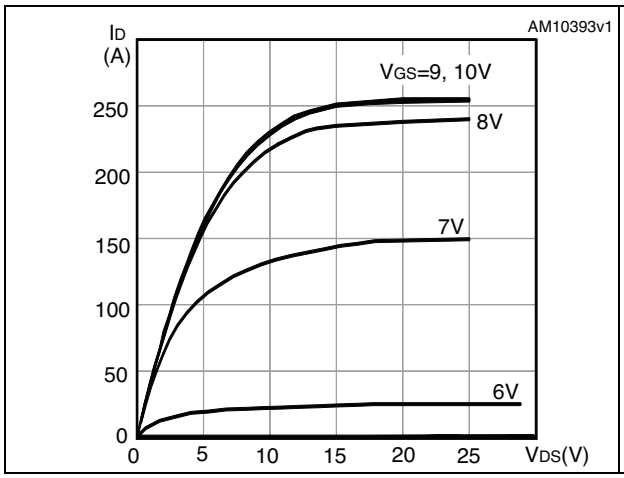


Figure 5. Transfer characteristics

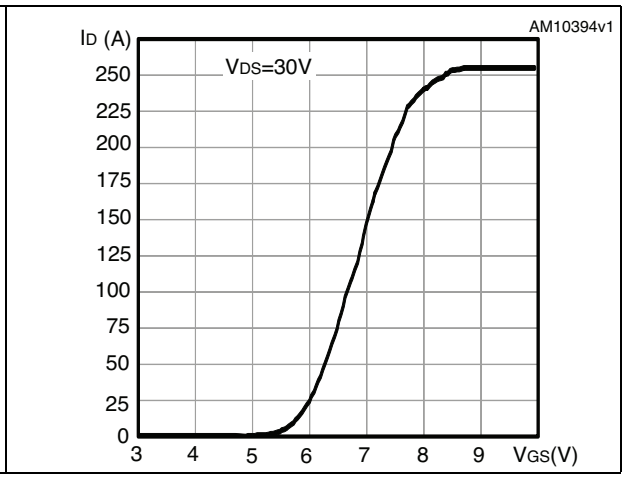


Figure 6. Gate charge vs gate-source voltage

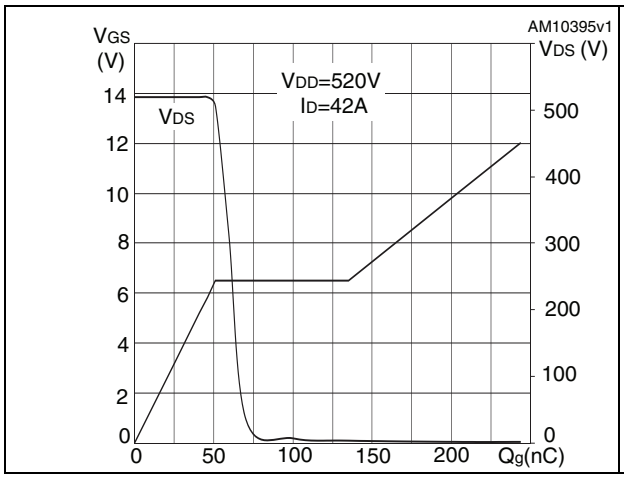


Figure 7. Static drain-source on resistance

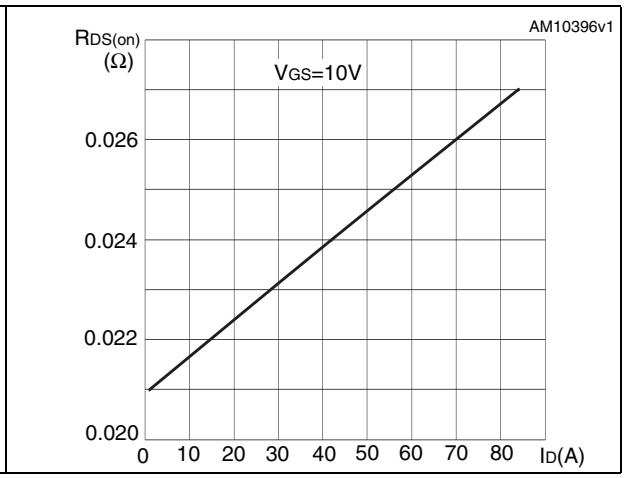


Figure 8. Capacitance variations

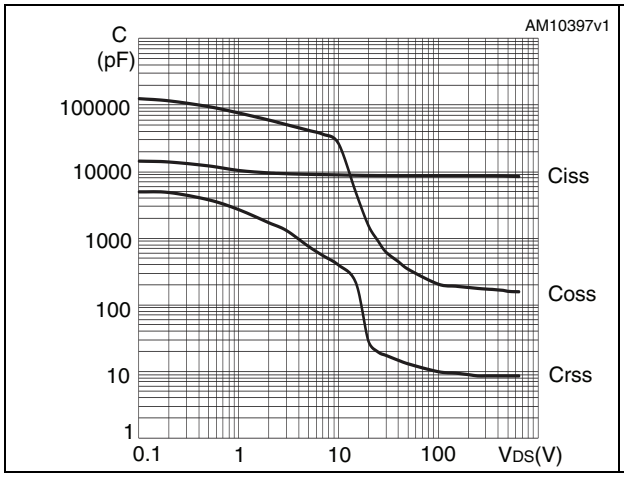


Figure 9. Output capacitance stored energy

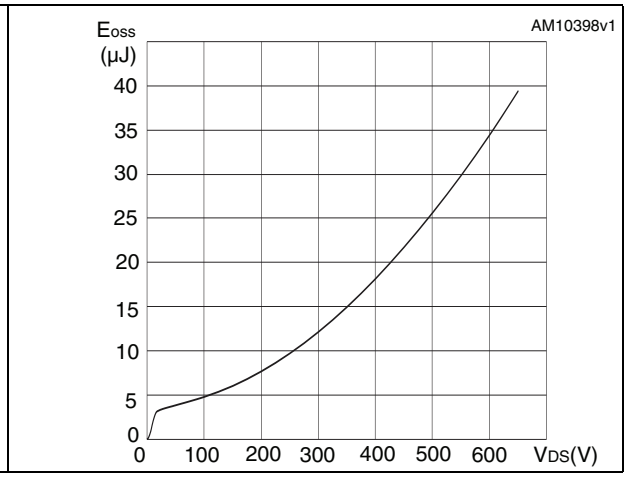


Figure 10. Normalized gate threshold voltage vs temperature

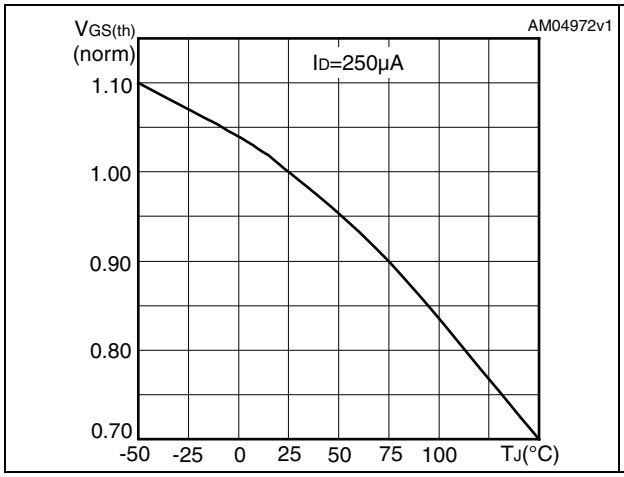


Figure 11. Normalized on-resistance vs temperature

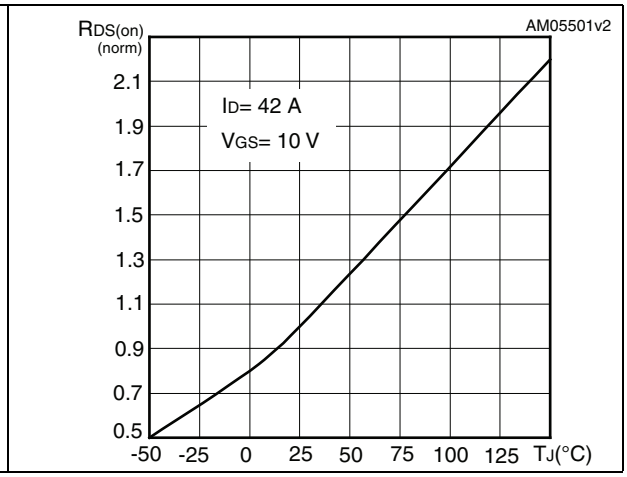


Figure 12. Source-drain diode forward characteristics

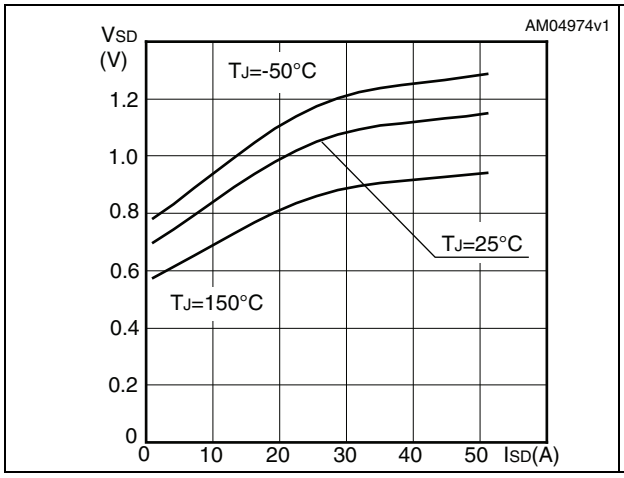


Figure 13. Normalized $V_{(BR)DSS}$ vs temperature

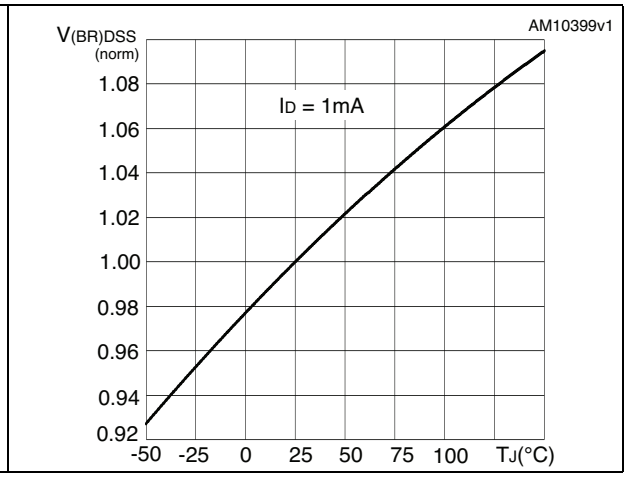
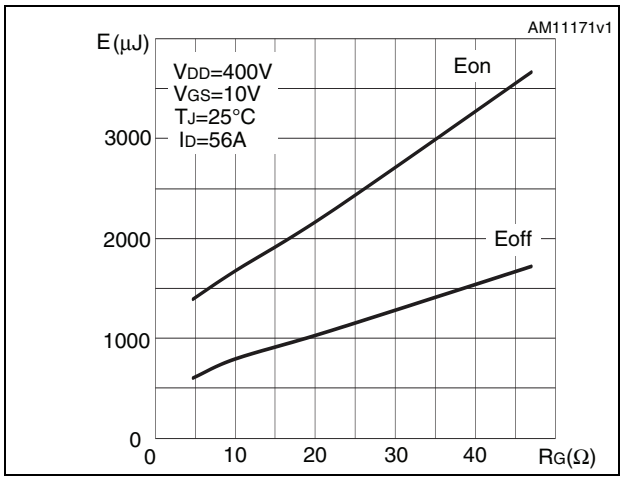


Figure 14. Switching losses vs gate resistance (1)



1. Eon including reverse recovery of a SiC diode

3 Test circuits

Figure 15. Switching times test circuit for resistive load

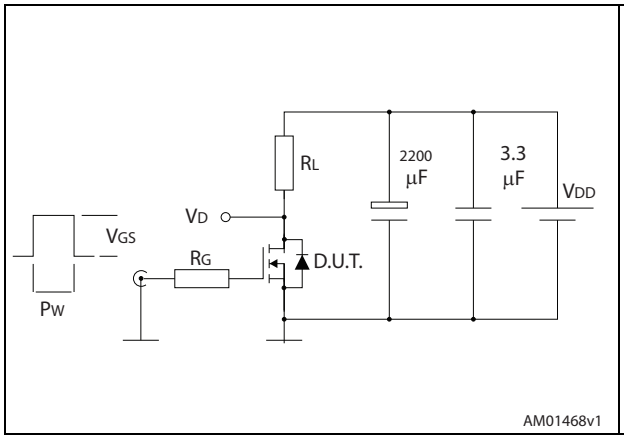


Figure 16. Gate charge test circuit

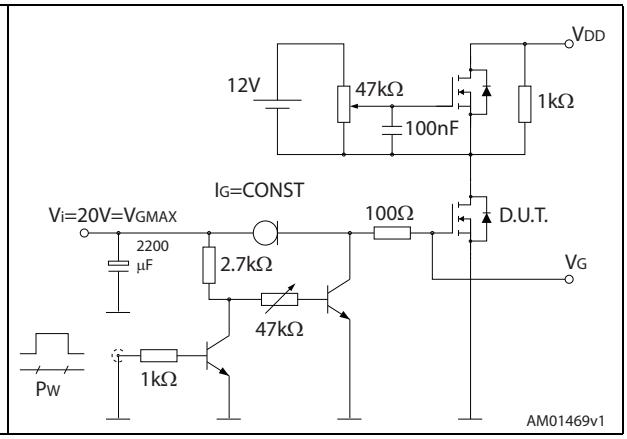


Figure 17. Test circuit for inductive load switching and diode recovery times

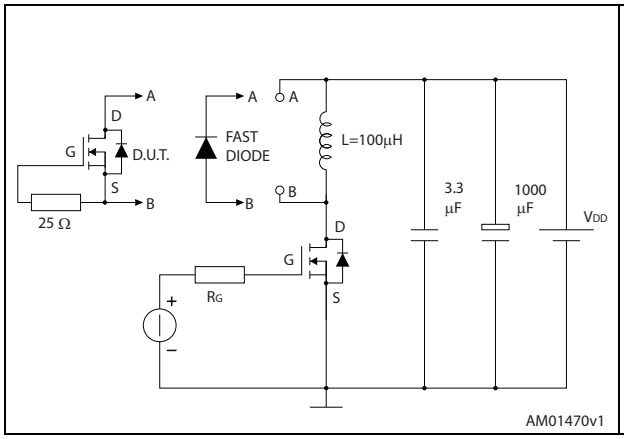


Figure 18. Unclamped inductive load test circuit

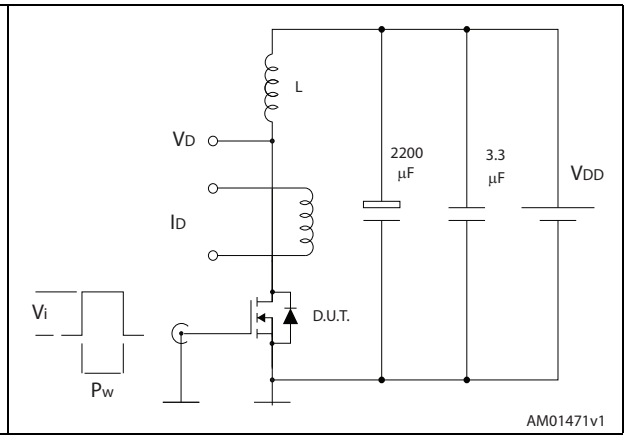


Figure 19. Unclamped inductive waveform

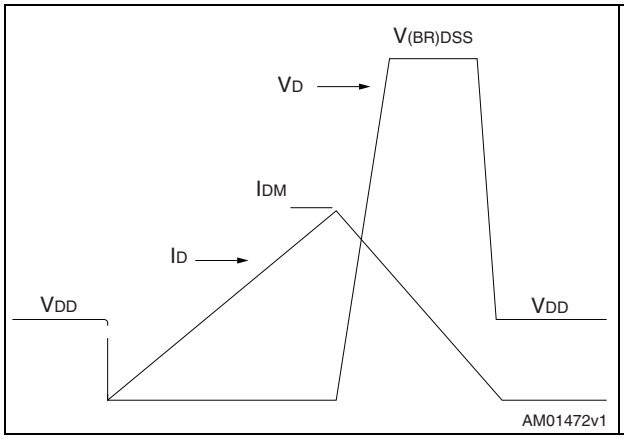
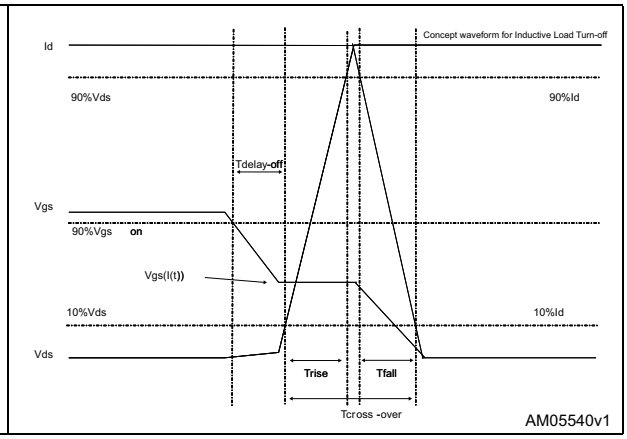


Figure 20. Switching time waveform



4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK® is an ST trademark.

Figure 21. TO-247 drawing

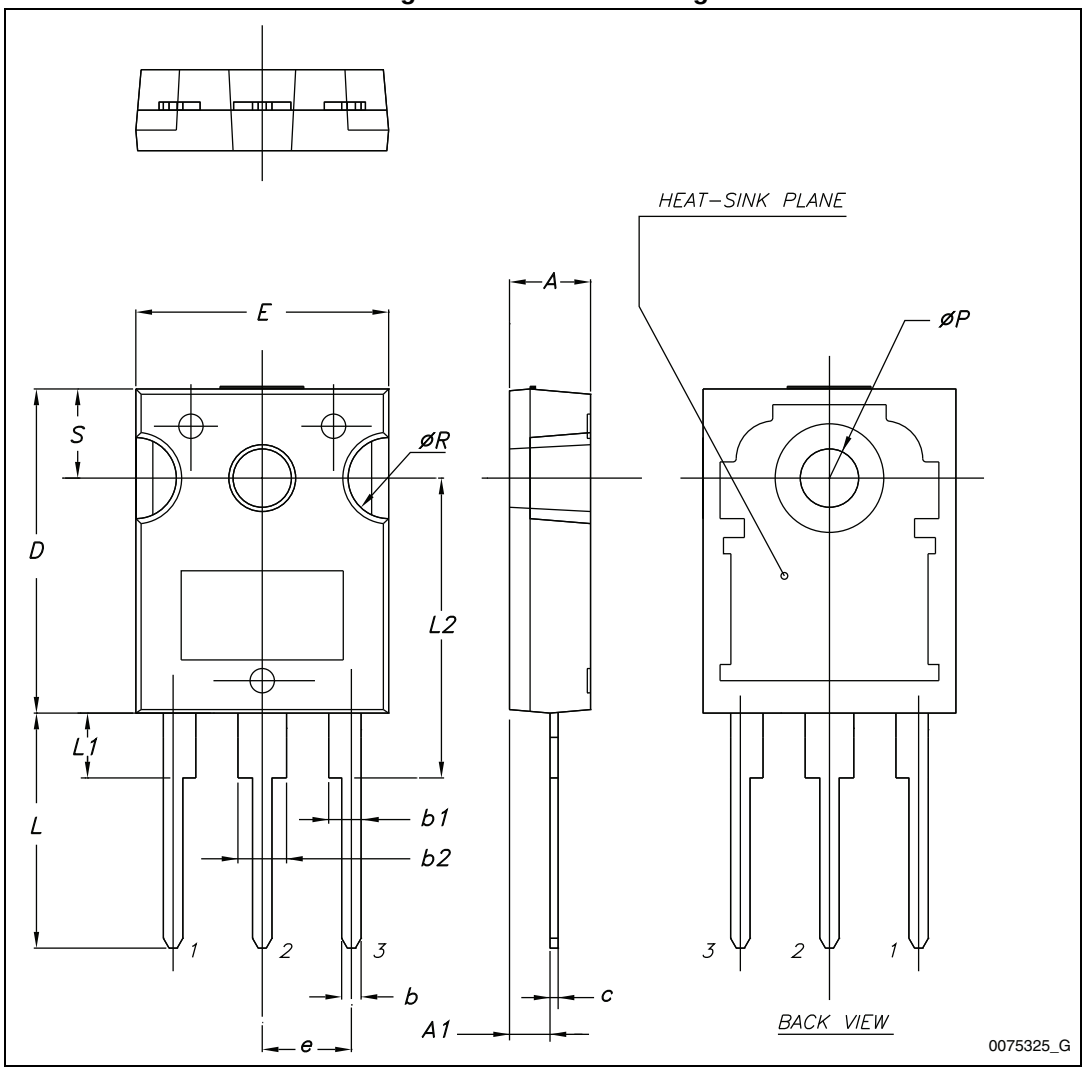


Table 8. TO-247 mechanical data

Dim.	mm.		
	Min.	Typ.	Max.
A	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
c	0.40		0.80
D	19.85		20.15
E	15.45		15.75
e	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
∅P	3.55		3.65
∅R	4.50		5.50
S	5.30	5.50	5.70

Figure 22. TO-247 long leads drawing

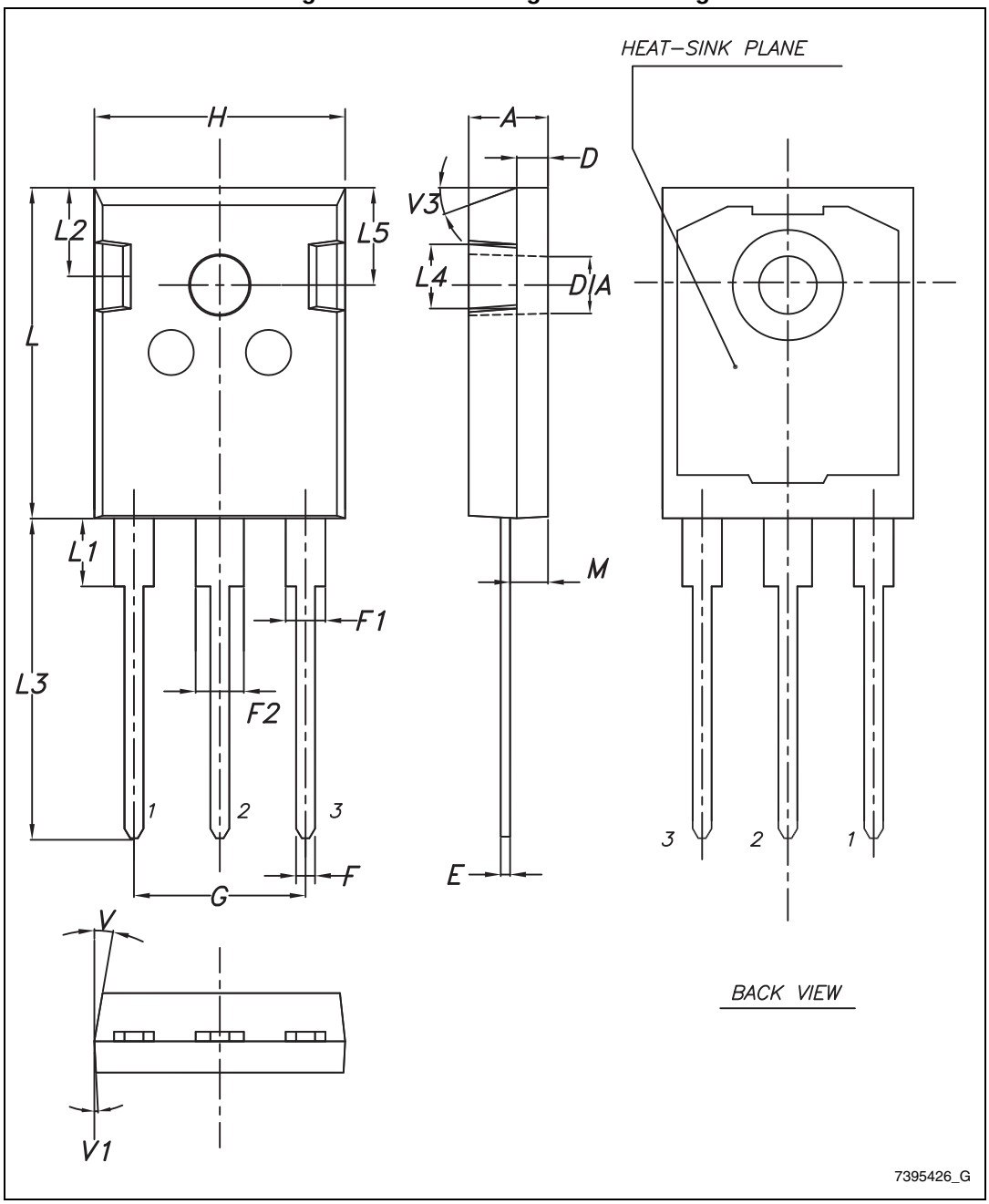


Table 9. TO-247 long leads mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.90		5.15
D	1.85		2.10
E	0.55		0.67
F	1.07		1.32
F1	1.90		2.38
F2	2.87		3.38
G		10.90 BSC	
H	15.77		16.02
L	20.82		21.07
L1	4.16		4.47
L2	5.49		5.74
L3	20.05		20.30
L4	3.68		3.93
L5	6.04		6.29
M	2.25		2.55
V		10°	
V1		3°	
V3		20°	
Dia.	3.55		3.66

5 Revision history

Table 10. Document revision history

Date	Revision	Changes
23-Nov-2011	1	First release.
09-Dec-2011	2	Document status promoted from preliminary data to datasheet.
12-Jun-2012	3	Updated title on the cover page.
30-Nov-2012	4	Added new part number: STWA88N65M5 Updated: *Section 4: Package mechanical data*
16-Jul-2014	5	– Updated: *Figure 4* and *5* – Minor text changes

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